



MP171A

700V, Non-Isolated, Offline Regulator, Up to 60mA Output Current with Improved EMI Performance

DESCRIPTION

The MP171A is a primary-side regulator that provides accurate constant voltage (CV) regulation without an optocoupler. It supports buck, boost, buck-boost, and flyback topologies.

The device's integrated 700V MOSFET simplifies the structure and reduces cost. This feature optimizes the device for offline, low-power applications such as home appliances and standby power.

The MP171A is a green-mode operation regulator. Both the peak current and switching frequency lower as the load decreases. This feature provides excellent efficiency at light load, and improves the overall efficiency.

Protection features include thermal shutdown (TSD), VCC under-voltage lockout (UVLO), overload protection (OLP), short-circuit protection (SCP), and open-loop detection.

The MP171A is available in TSOT23-5 and SOIC-8 packages.

FEATURES

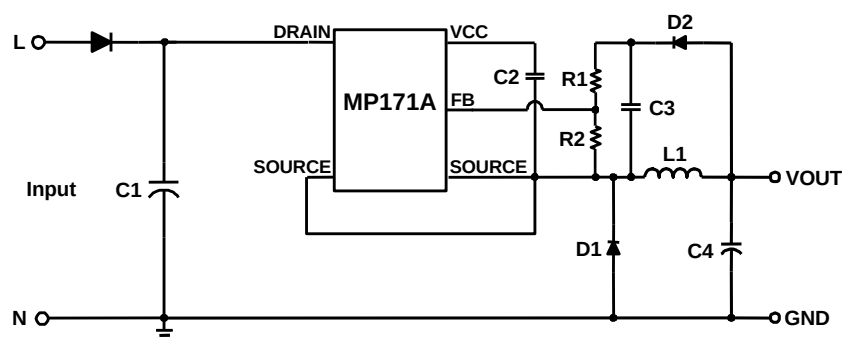
- Primary-Side CV Control
- Supports Buck, Boost, Buck-Boost, and Flyback Topologies
- Integrated 700V MOSFET and Current Source
- Under 30mW No-Load Power Consumption
- Up to 2W Output Power
- Maximum DCM Output Current below 40mA
- Maximum CCM Output Current below 60mA
- Low VCC Operating Current
- Frequency Foldback
- Limited Maximum Frequency
- Peak Current Compression
- Internally Biased VCC
- TSD, UVLO, OLP, SCP, Open-Loop Detection
- Available in TSOT23-5 and SOIC-8 Packages

APPLICATIONS

- Home Appliances, White Goods, and Consumer Electronics
- Industrial Controls
- Standby Power

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TYPICAL APPLICATION



ORDERING INFORMATION

Part Number	Package	Top Marking	MSL Rating
MP171AGJ*	TSOT23-5	See Below	1
MP171AGS**	SOIC-8	See Below	2

* For Tape & Reel, add suffix -Z (e.g. MP171AGJ-Z).

** For Tape & Reel, add suffix -Z (e.g. MP171AGS-Z).

TOP MARKING (MP171AGJ)

| BMXY

BMX: Product code of MP171AGJ

Y: Year code

TOP MARKING (MP171AGS)

MP171A
LLLLLLLL
MPSYWW

MP171A: Part number

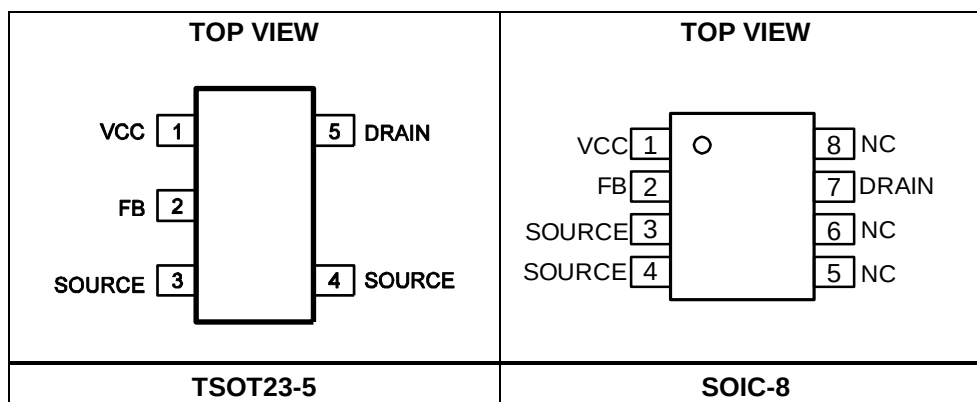
LLLLLLLL: Lot number

MPS: MPS prefix

Y: Year code

WW: Week code

PACKAGE REFERENCE



PIN FUNCTIONS

Pin # TSOT23-5	Pin # SOIC-8	Name	Description
1	1	VCC	Control circuit power supply.
2	2	FB	Regulator feedback.
3, 4	3, 4	SOURCE	Internal power MOSFET source. Ground reference for the VCC and FB pins.
5	7	DRAIN	Internal power MOSFET drain. High-voltage current source input.
	5, 6, 8	N/C	Not connected.

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Drain to source ($T_J = 25^\circ\text{C}$).....	-0.3V to +700V
All other pins.....	-0.3V to +6.5V
Continuous power dissipation ($T_A = 25^\circ\text{C}$) ⁽²⁾	
TSOT23-5.....	1W
SOIC-8	1W
Junction temperature	150°C
Lead temperature	260°C
Storage temperature	-60°C to +150°C

ESD Rating

Human body model (HBM)	2.0kV
Charged device model (CDM)	
TSOT23-5.....	1.2kV
SOIC-8.....	1.5kV

Recommended Operating Conditions ⁽³⁾

Operating junction temp (T_J)	-40°C to +125°C
Operating VCC range	5.5V to 5.7V

<i>Thermal Resistance</i> ⁽⁴⁾	θ_{JA}	θ_{JC}
TSOT23-5	100	55 ... °C/W
SOIC-8	96	45 ... °C/W

Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-to-ambient thermal resistance θ_{JA} , and the ambient temperature T_A . The maximum allowance continuous power dissipation at any ambient temperature is calculated with P_D (MAX) = $(T_J$ (MAX) - T_A) / θ_{JA} . Exceeding the maximum allowance power dissipation will produce an excessive die temperature, causing the regulator to go into thermal shutdown. Internal thermal shutdown circuit protects the device from permanent damage.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.

ELECTRICAL CHARACTERISTICS

VCC = 5.5V, T_J = -40°C to +125°C, min and max values are guaranteed by characterization, typical values are tested under 25°C, unless otherwise noted.

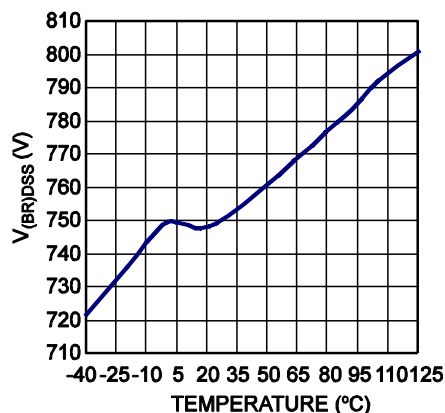
Parameter	Symbol	Condition	Min	Typ	Max	Units
Start-Up Current Source and Internal MOSFET (DRAIN)						
Internal regulator supply current	I _{REGULATOR}	VCC = 4V, V _{DRAIN} = 100V	2.2	4.1	6	mA
DRAIN leakage current	I _{LEAK}	VCC = 5.8V, V _{DRAIN} = 400V		10	17	μA
Breakdown voltage	V _{(BR)DSS}	T _J = 25°C	700			V
On resistance	R _{ON}	T _J = 25°C		20	25	Ω
Supply Voltage Management (VCC)						
VCC increasing level where the internal regulator stops	VCC _{OFF}		5.4	5.7	6	V
VCC decreasing level where the internal regulator turns on	VCC _{ON}		5.1	5.5	5.8	V
VCC regulator on and off hysteresis			130	250		mV
VCC decreasing level where the IC stops	VCC _{STOP}		3	3.4	3.6	V
VCC decreasing level where the protection phase ends	VCC _{PRO}		2	2.5	2.8	V
Internal IC consumption	I _{CC}	f _{SW} = 36kHz, D = 64%			720	μA
Internal IC consumption (no switching)					200	μA
Internal IC consumption (latch-off phase)	ICCLATCH	VCC = 5.3V		16	24	μA
Internal Current Sense						
Peak current limit	I _{LIMIT}	T _J = 25°C	85	105	125	mA
Leading-edge blanking	t _{LEB1}			350		ns
SCP threshold	I _{SCP}	T _J = 25°C	220	300	400	mA
Leading-edge blanking for SCP ⁽¹⁾	t _{LEB2}			180		ns
Feedback Input (FB)						
Minimum off time	t _{MINOFF}		7.5	10	12.5	μs
Maximum on time	t _{MAXON}		13	18	23	μs
Primary MOSFET feedback turn-on threshold	V _{FB}		2.45	2.55	2.65	V
OLP feedback trigger threshold	V _{FB_OLP}		1.64	1.74	1.84	V
OLP delay time	t _{OLP}	f _{SW} = 36 kHz		175		ms
Open-loop detection	V _{OLD}		0.4	0.5	0.6	V
Thermal Shutdown						
Thermal shutdown threshold ⁽⁵⁾				150		°C
Thermal shutdown recovery hysteresis ⁽⁵⁾				30		°C

Note:

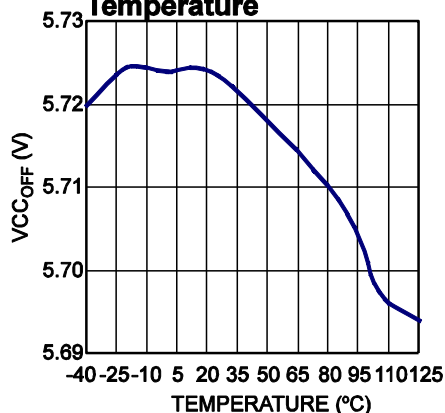
5) This parameter is guaranteed by design.

TYPICAL CHARACTERISTICS

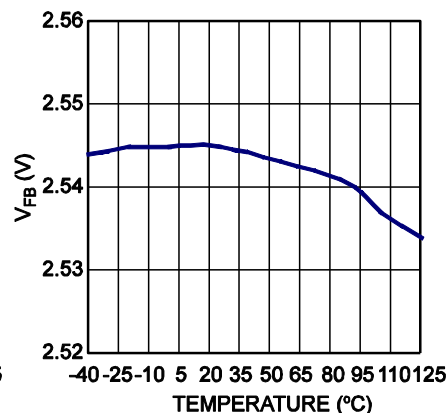
Breakdown Voltage vs. Temperature



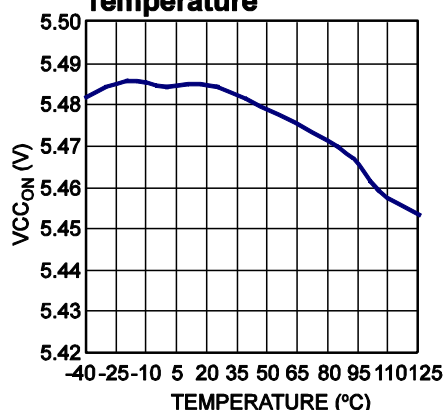
VCC Increasing Level at which the Internal Regulator Stops vs. Temperature



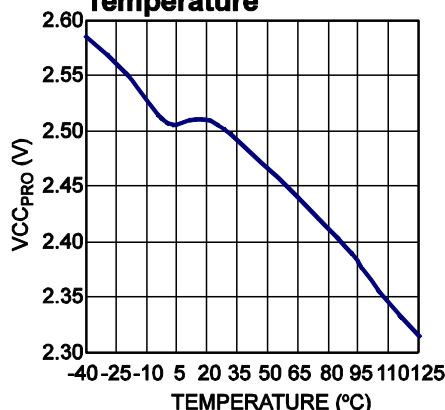
Feedback Voltage vs. Temperature



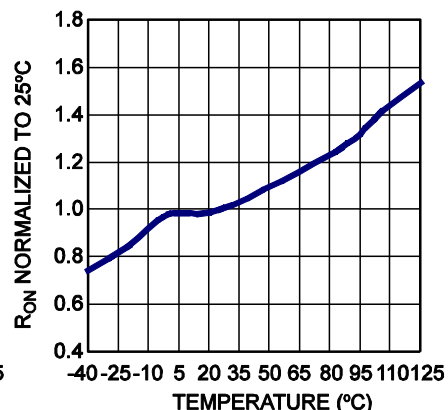
VCC Decreasing Level at which the Internal Regulator Turns On vs. Temperature



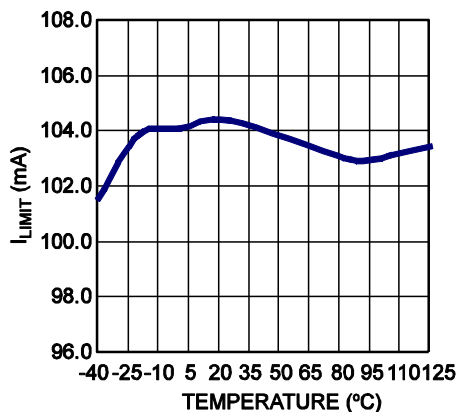
VCC Decreasing Level at which the Protection Phase Ends vs. Temperature



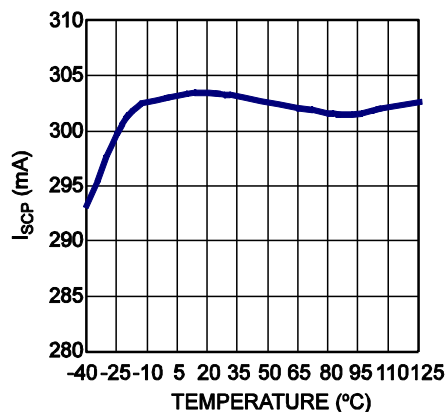
On-State Resistance vs. Temperature



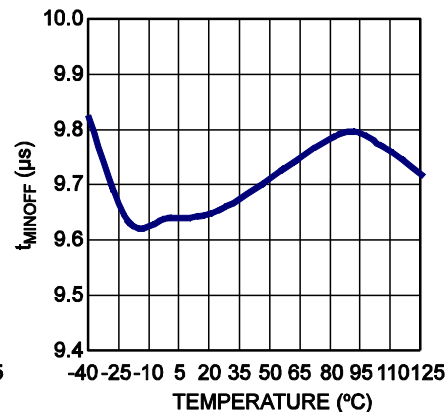
Peak Current Limit vs. Temperature



SCP Point vs. Temperature



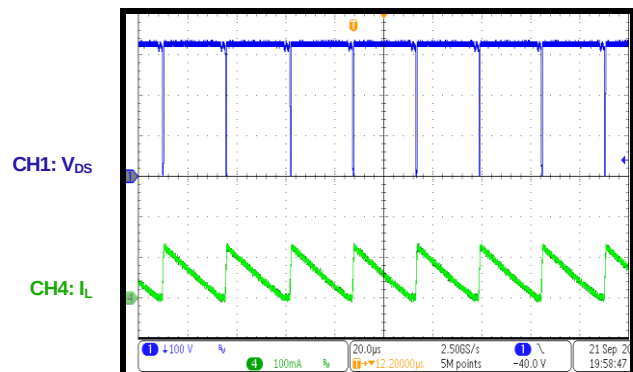
Minimum Off Time vs. Temperature



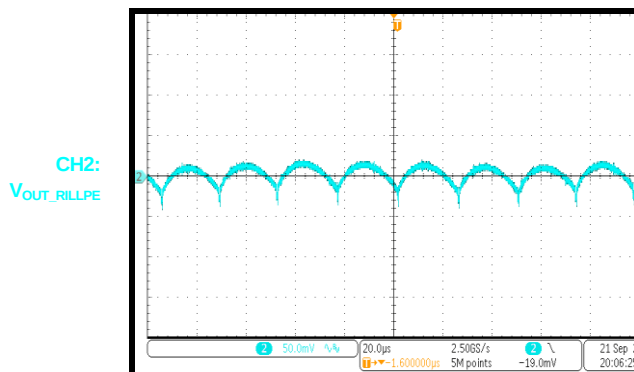
TYPICAL PERFORMANCE CHARACTERISTICS

$V_{IN} = 230VAC$, $V_{OUT} = 5V$, $I_{OUT} = 50mA$, $L = 1mH$, $C_{OUT} = 22\mu F$, $T_A = 25^{\circ}C$, unless otherwise noted.

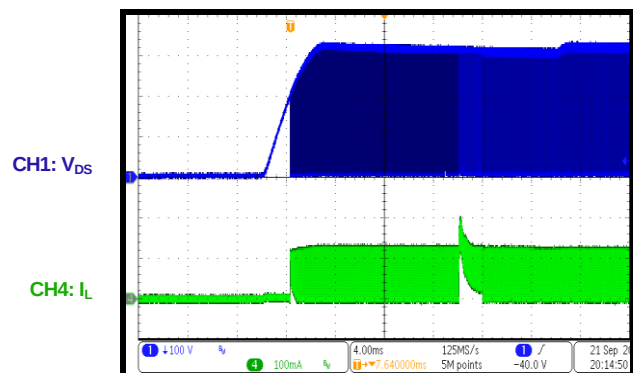
Steady State



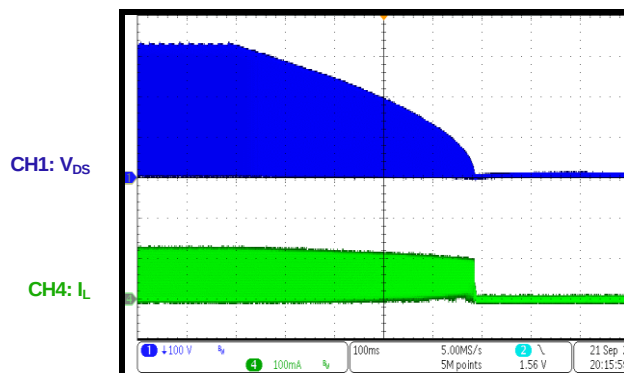
Output Ripple



Start-Up

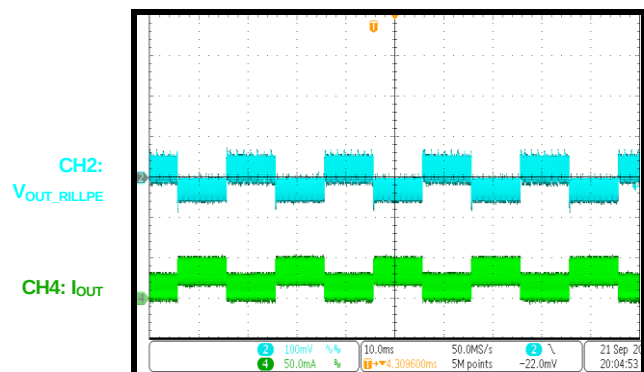


Shutdown

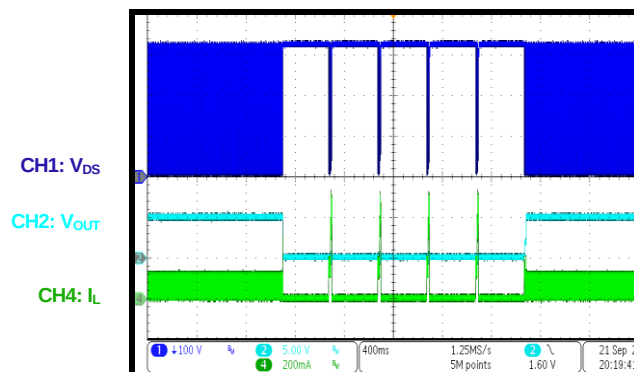


Load Transient

Half-load to full load



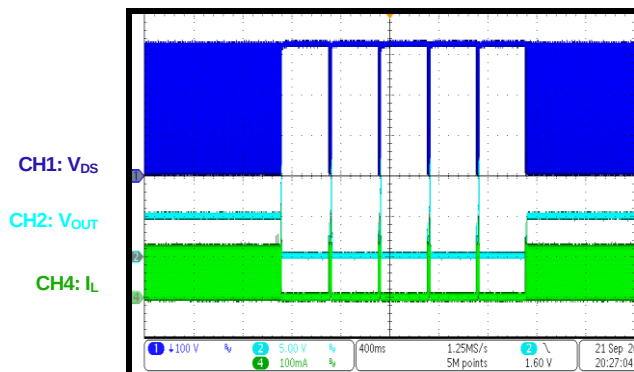
SCP Entry and Recovery



TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

$V_{IN} = 230VAC$, $V_{OUT} = 5V$, $I_{OUT} = 50mA$, $L = 1mH$, $C_{OUT} = 22\mu F$, $T_A = 25^{\circ}C$, unless otherwise noted.

Open-Loop Entry and Recovery



FUNCTIONAL BLOCK DIAGRAM

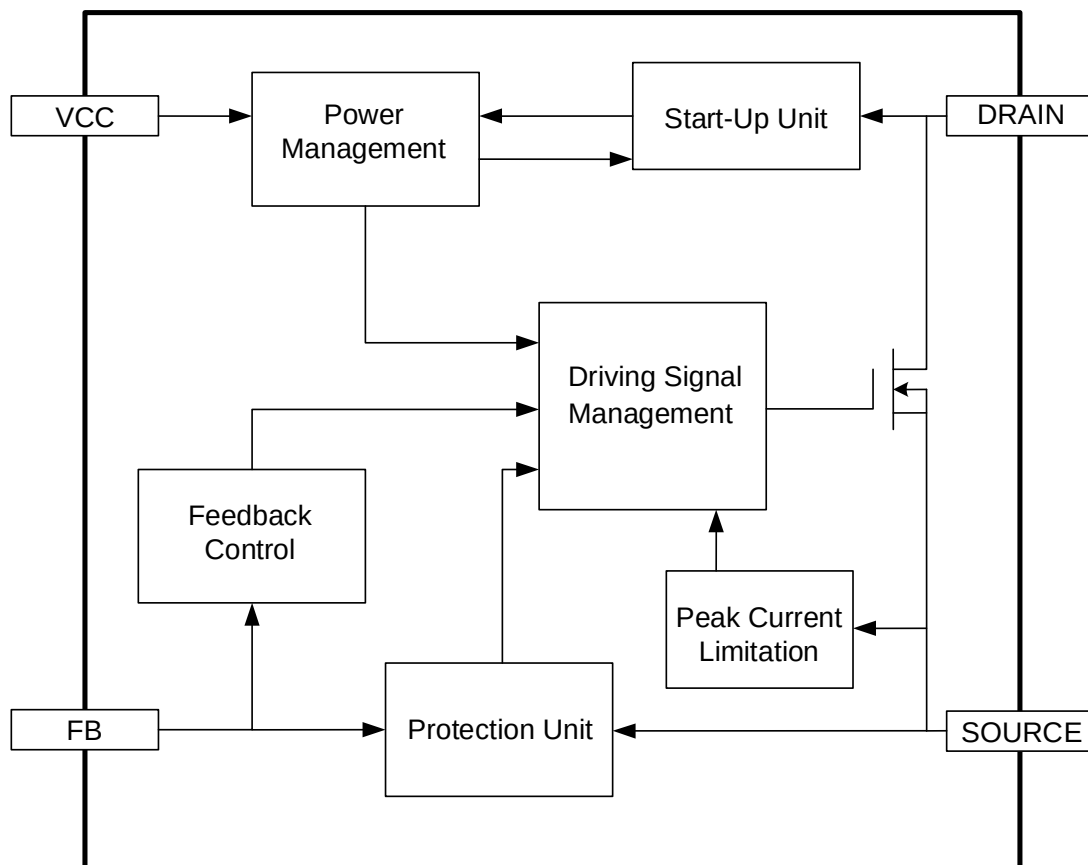


Figure 1: Functional Block Diagram

OPERATION

The MP171A is a green-mode operation regulator. The peak current and switching frequency both drop with a decreasing load. As a result, the device offers excellent light-load efficiency and improves overall efficiency. The regulator incorporates multiple features and operates with a minimal number of external components.

The device acts as a fully integrated regulator when used in buck topology (see the Typical Application on page 1).

Start-Up and Under-Voltage Lockout (UVLO)

The internal high-voltage regulator self-supplies the IC from DRAIN. When the VCC voltage reaches VCC_{OFF}, the IC switches and the internal high-voltage regulator turns off. The internal high-voltage regulator turns on to charge the external VCC capacitor when the VCC voltage falls below VCC_{ON}. A capacitor with a low μF value is recommended to maintain the VCC voltage, and lower the capacitor cost.

The IC stops switching when the VCC voltage drops below VCC_{STOP}.

Under fault conditions, such as overload protection (OLP), short-circuit protection (SCP), and thermal shutdown (TSD), the IC stops switching. The internal current source I_{CCLATCH} (about 16 μA) discharges the VCC capacitor. The internal high-voltage regulator does not charge the VCC capacitor until the VCC voltage drops below VCC_{PRO}. The restart time can be estimated with Equation (1):

$$t_{\text{RESTART}} = C_{\text{VCC}} \times \left(\frac{V_{\text{CC}} - V_{\text{CC_PRO}}}{I_{\text{CCLATCH}}} + \frac{V_{\text{CC_OFF}} - V_{\text{CC_PRO}}}{I_{\text{REGULATOR}}} \right) \quad (1)$$

Soft Start (SS)

The MP171A stops operation when the VCC voltage drops below VCC_{STOP}. Operation resumes when VCC charges to VCC_{OFF}. When the IC initiates operation, there is always a soft-start period. The soft start limits the minimum off time to prevent the inductor current from overshooting.

The MP171A adopts a two-phase minimum off time limit soft start. Each phase retains 256 switching cycles. During a soft start, the off time

limit gradually shortens from 48 μs to 18 μs until it reaches the standard off time limit (see Figure 2).

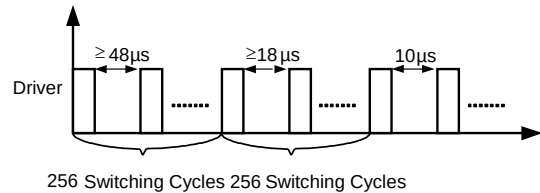


Figure 2: t_{MINOFF} at Start-Up

Constant Voltage Operation

Take Typical Application on page 1 for reference, the MP171A regulates the output voltage by monitoring the sampling capacitor (C3).

At the beginning of each cycle, the integrated MOSFET turns on when the feedback voltage drops below the 2.55V reference voltage (V_{FB}) and indicates insufficient output. The peak current limitation determines the on period. After the on period, the integrated MOSFET turns off.

The sampling capacitor (C3) voltage charges to the output voltage when the freewheeling diode (D1) turns on. The sampling capacitor (C3) samples and holds the output voltage for output regulation. The sampling capacitor's (C3) voltage drops when the L1 inductor current falls below the output current. When the feedback voltage drops below the 2.55V reference voltage, a new switching cycle begins. Figure 3 shows this operation in continuous conduction mode (CCM).

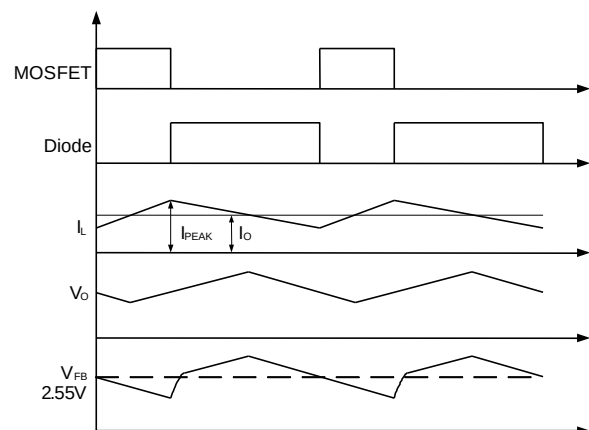


Figure 3: V_{FB} vs. V_O

The output voltage (V_O) can be estimated with Equation (2):

blanked. This guarantees successful start-up with a large output capacitor.

Leading-Edge Blanking (LEB)

An internal leading-edge blanking (LEB) unit avoids premature switching pulse termination due to a turn-on spike. Turn-on spikes are caused by parasitic capacitance and reverse recovery of the freewheeling diode. During the blanking time, the current comparator is disabled and cannot turn off the external MOSFET. Figure 5 shows leading-edge blanking.

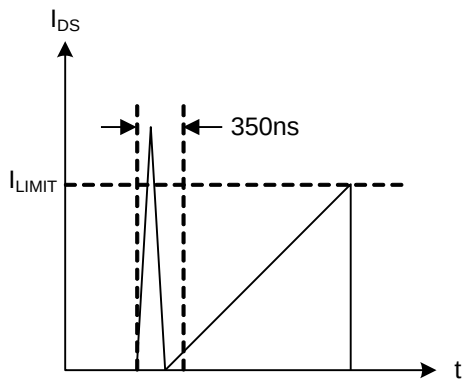


Figure 5: Leading-Edge Blanking

APPLICATION INFORMATION

Table 1: Common Topologies for the MP171A

Topology	Circuit Schematic	Features
High-side buck		- No isolation - Positive output - Low cost - Direct feedback
High-side buck boost		- No isolation - Negative output - Low cost - Direct feedback
Boost		- No isolation - Positive output - Low cost - Direct feedback
Flyback		- Isolation - Positive output - Low cost - Indirect feedback

Topology Options

The MP171A can be used in common topologies, such as buck, boost, buck-boost, and flyback (see Table 1 on page 13).

The component selections below are based on the MP171A's typical application (see page 1).

Component Selection

Input Capacitor

The input capacitor supplies the DC input voltage for the converter. Figure 6 shows the typical DC bus voltage waveform of a half-wave rectifier and a full-wave rectifier.

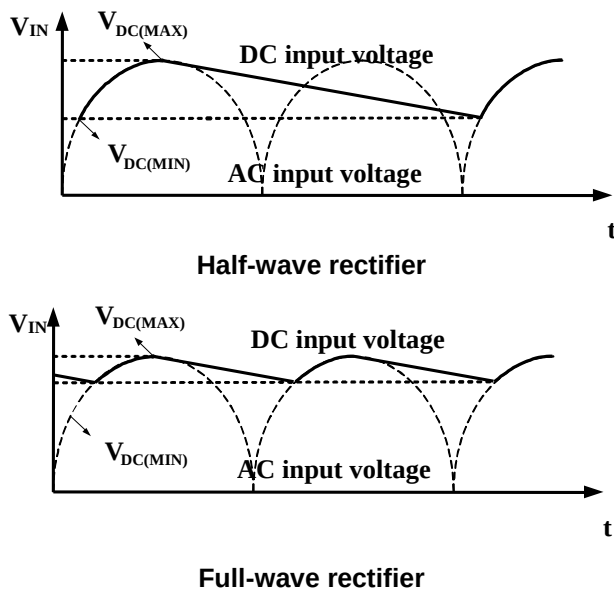


Figure 6: Input Voltage Waveform

A half-wave rectifier typically requires an input capacitor (about 3μF/W) for the universal input condition. When using the full-wave rectifier, the input capacitor should be between 1.5μF/W and 2μF/W for the universal input condition.

Avoid a minimum DC voltage below 70V. A low DC input voltage can cause thermal instability. A half-wave rectifier is recommended for output applications that do not require more than 2W; otherwise, a full-wave rectifier is recommended for output applications that require more than 2W.

Inductor

The MP171A has a minimum off time limit that determines the maximum power output. The maximum power increases as the inductance increases. A small inductor may cause a failure

at full load, but a larger inductor means a higher overload protection (OLP) load. It is recommended to select an inductor with the lowest value possible to supply the rated power.

The maximum power (P_{OMAX}) can be estimated with Equation (7) and Equation (8) for CCM and DCM, respectively:

$$P_{OMAX} = V_{OUT} \times (I_{PEAK} - \frac{V_{OUT} \times t_{MINOFF}}{2L}) \quad (7)$$

$$P_{OMAX} = \frac{1}{2} L \times I_{PEAK}^2 \times \frac{1}{t_{MINOFF}} \quad (8)$$

For mass production, consider tolerance on the parameters (e.g. peak current limitation and minimum off time).

Freewheeling Diode

The diode should be selected based on the maximum input voltage and peak current.

The freewheeling diode's reverse recovery can affect efficiency and circuit operation for CCM conditions. A diode such as the EGC10JH is recommended.

Output Capacitor

The output capacitor is required to maintain the DC output voltage. The output voltage ripple can be calculated with Equation (9) and Equation (10) for CCM and DCM, respectively:

$$V_{CCM_RIPPLE} = \frac{\Delta I}{8f_{SW} \times C_O} + \Delta I \times R_{ESR} \quad (9)$$

$$V_{DCM_RIPPLE} = \frac{I_O}{f_{SW} \times C_O} \times \left(\frac{I_{PEAK} - I_O}{I_{PEAK}} \right)^2 + I_{PEAK} \times R_{ESR} \quad (10)$$

To reduce the output voltage ripple, use ceramic, tantalum, or low-ESR electrolytic capacitors. A maximum 470μF capacitance is recommended in typical applications to avoid triggering SCP during start-up.

Feedback Resistors

The resistor divider determines the output voltage. Choose appropriate R1 and R2 values to maintain the feedback voltage at 2.55V. R2 should typically be between 5kΩ and 10kΩ. Avoid a large R2 value.

Feedback Capacitor

The feedback capacitor provides a sample and hold function. Small capacitors result in poor

regulation at light loads, and large capacitors affect the circuit operation. The optimal capacitor value can be estimated with Equation (11):

$$\frac{1}{2} \times \frac{V_{OUT}}{R1+R2} \times \frac{C_O}{I_{OUT}} \leq C_{FB} \leq \frac{V_{OUT}}{R1+R2} \times \frac{C_O}{I_{OUT}} \quad (11)$$

Dummy Load

A dummy load is required to maintain the load regulation. This ensures there is sufficient inductor energy to charge the sample and hold the capacitor to detect the output voltage. A 3mA dummy load is required; it can be adjusted according to the regulated voltage.

For applications that require a 30mW no-load consumption, there is a tradeoff between small no-load consumption and optimal no-load regulation. Use a Zener diode to reduce no-load consumption if no-load regulation is not vital for the application.

Auxiliary VCC Supply

For an application where V_O exceeds 7V, the MP171A can meet a 30mW no-load power requirement. To do this, the IC requires an external VCC supply to reduce overall power consumption (see Figure 7).

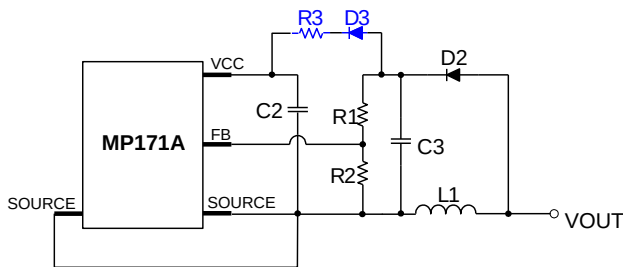


Figure 7: Auxiliary VCC Supply Circuit

This auxiliary VCC supply is derived from the resistor connected between C2 and C3. C3 should be greater than the recommendation (see the Feedback Capacitor section on page 14). D3 is used in case VCC interferes with FB. R3 is calculated using Equation (12):

$$R3 \approx \frac{V_{OUT} - V_{FW} - 5.8V}{I_S} \quad (12)$$

Where I_S is the VCC consumption under a no-load condition, and V_{FW} is the forward voltage drop of D3. R3 should be adjusted to meet the

actual I_S , because it varies in different applications. In a particular configuration, I_S is measured at about 200μA.

Surge Performance

Choose an appropriate input capacitor value to obtain an efficient surge performance. Figure 8 shows the half-wave rectifier.

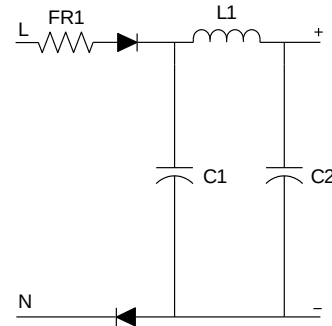


Figure 8: Half-Wave Rectifier

Table 2 shows the capacitance required under normal conditions for different surge voltages. In this example, FR1 is a 20Ω/2W fused resistor and L1 is 1mH.

Table 2: Recommended Capacitance

Surge Voltage	500V	1000V	2000V
C1	1μF	2.2μF	3.3μF
C2	1μF	2.2μF	3.3μF

Design Example

Table 3 shows a design example for the following application guideline specifications:

Table 3: Design Example

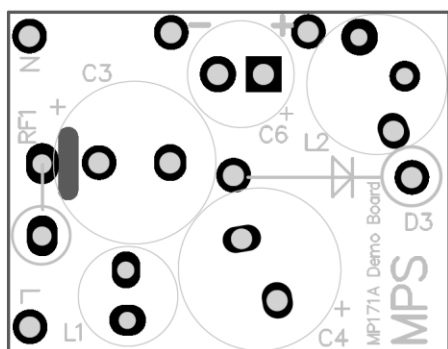
V_{IN}	85VAC to 265VAC
V_{OUT}	5V
I_{OUT}	50mA

Figure 10 on page 17 shows a detailed application schematic. For the typical performance and circuit waveforms of the device, see the Typical Performance Characteristics section on page 7. Refer to the related evaluation board datasheets for additional information.

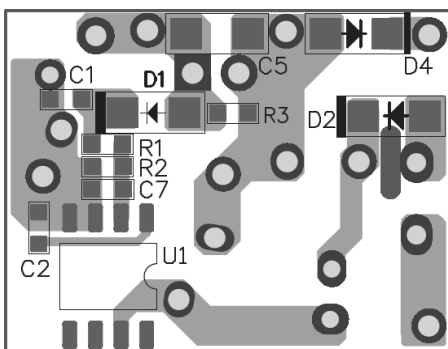
PCB Layout Guidelines

PCB layout is vital for stable operation, good EMI, and thermal performance. For the best results, refer to Figure 9 and follow the guidelines below:

1. Minimize the loop area formed by the input capacitor, IC, freewheeling diode, inductor, and output capacitor.
2. Place the power inductor away from the input filter.
3. Minimize the loop area to the inductor (see Figure 9).
4. Place a capacitor valued at several hundred pF between FB and SOURCE, as close to the IC as possible.
5. Connect the exposed pads or large copper area to DRAIN to improve thermal performance.



Top Layer



Bottom Layer

Figure 9: Recommended PCB Layout

TYPICAL APPLICATION CIRCUIT

Figure 10 shows a typical application example of a 5V, 50mA, non-isolated power supply using the MP171A.

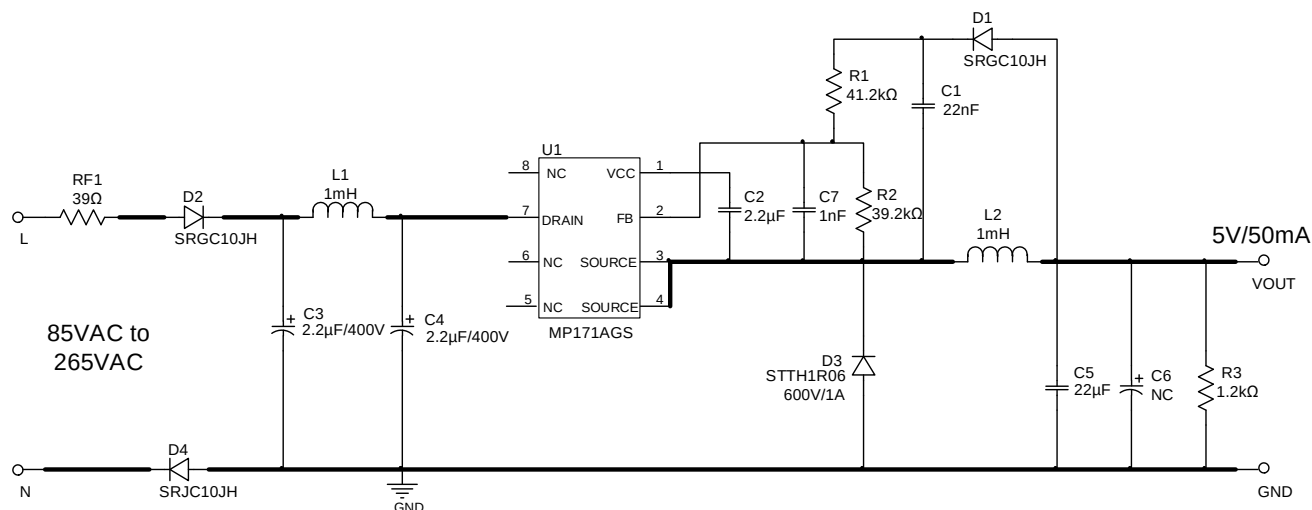
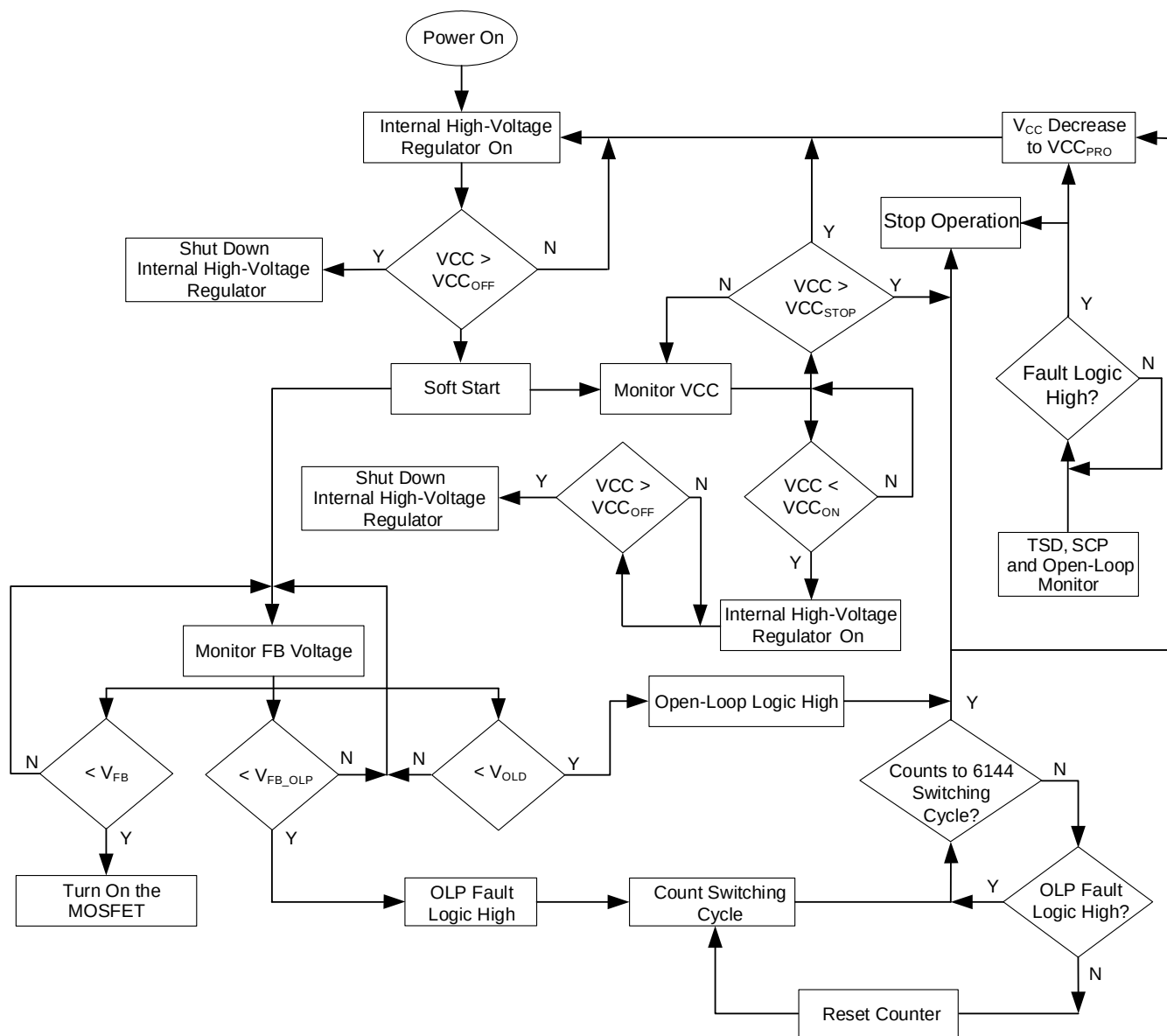


Figure 10: Typical Application at 5V, 50mA

FLOWCHART



UVLO, SCP, OLP, OTP, and open-loop protections are auto-restart.

Figure 11: Control Flowchart

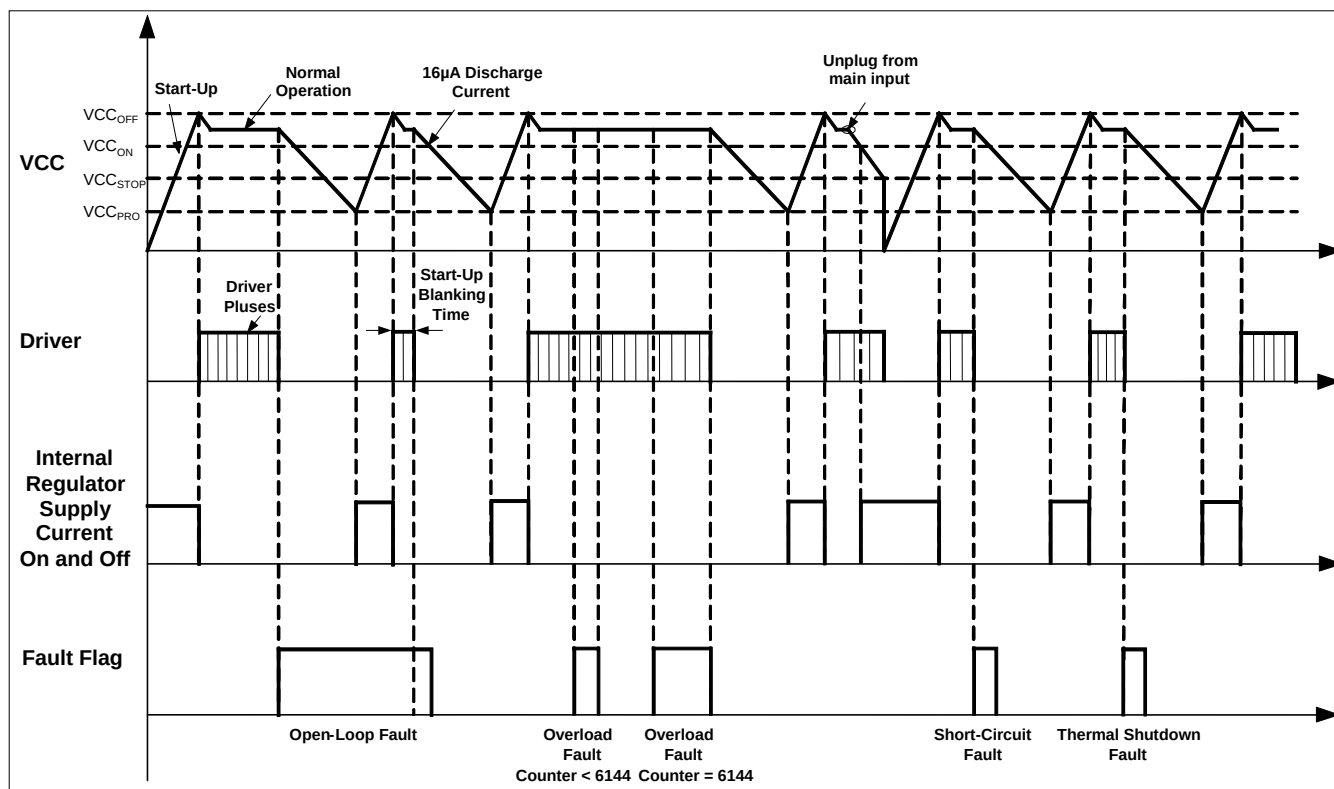
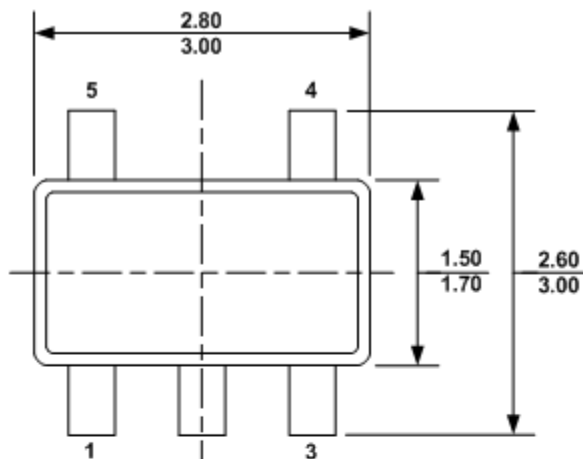


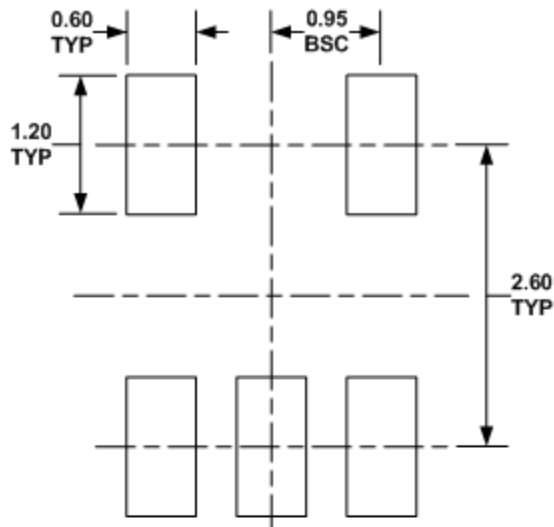
Figure 12: Signal Evolution in the Presence of a Fault

PACKAGE INFORMATION

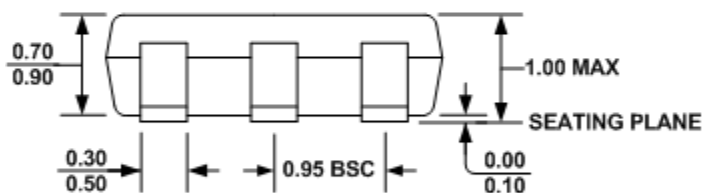
TSOT23-5



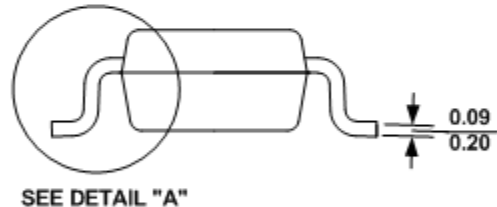
TOP VIEW



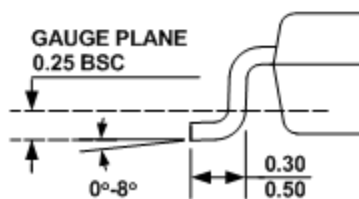
RECOMMENDED LAND PATTERN



FRONT VIEW



SIDE VIEW



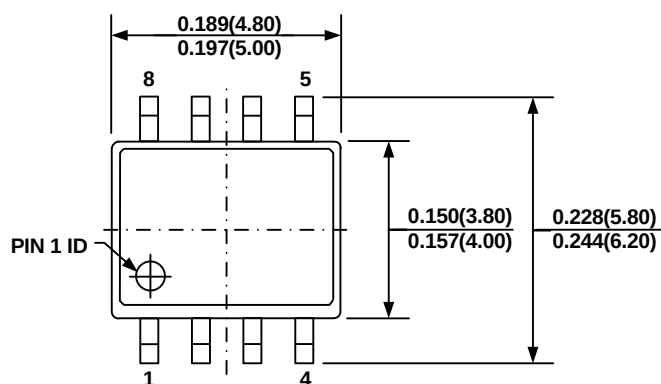
DETAIL "A"

NOTE:

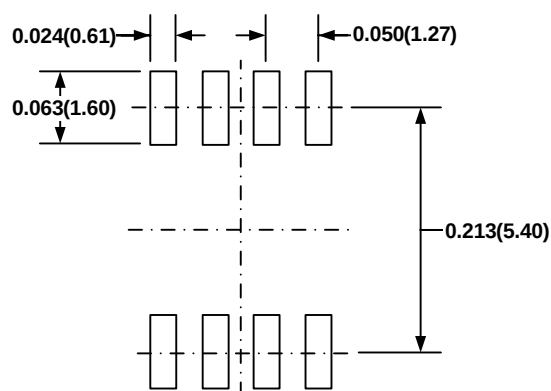
- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURR.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.10 MILLIMETERS MAX.
- 5) DRAWING CONFORMS TO JEDEC MO-193, VARIATION AA.
- 6) DRAWING IS NOT TO SCALE.

PACKAGE INFORMATION (continued)

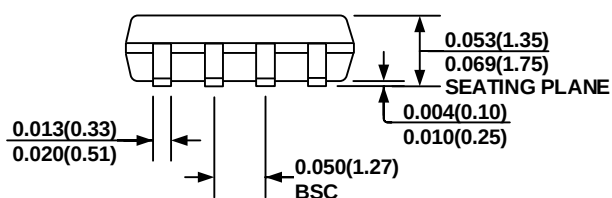
SOIC-8



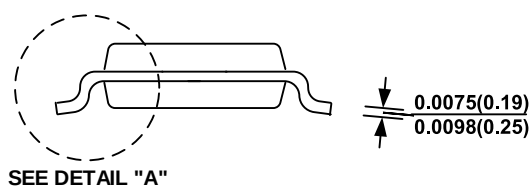
TOP VIEW



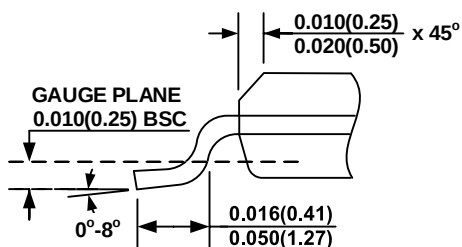
RECOMMENDED LAND PATTERN



FRONT VIEW



SIDE VIEW

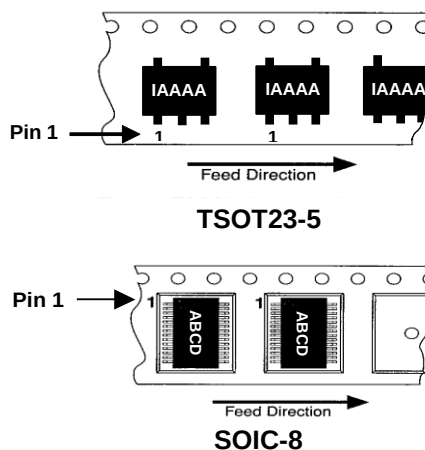
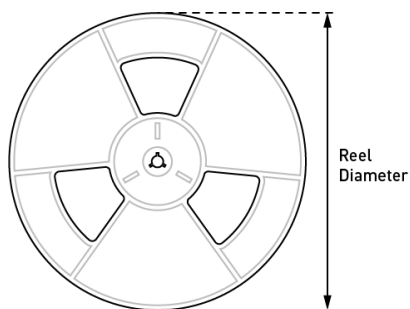


DETAIL "A"

NOTE:

- 1) CONTROL DIMENSION IS IN INCHES. DIMENSION IN BRACKET IS IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.004" INCHES MAX.
- 5) DRAWING CONFORMS TO JEDEC MS-012, VARIATION AA.
- 6) DRAWING IS NOT TO SCALE.

CARRIER INFORMATION



Part Number	Package Description	Quantity/Reel	Quantity/Tube	Reel Diameter	Carrier Tape Width	Carrier Tape Pitch
MP171AGJ-Z	TSOT23-5	3000	N/A	7in	8mm	4mm
MP171AGS-Z	SOIC-8	2500	100	13in	12mm	8mm

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